# 74HC123-Q100; 74HCT123-Q100

Dual retriggerable monostable multivibrator with reset

Rev. 3.1 — 3 September 2020 Product data sheet

# 1. General description

The 74HC123-Q100; 74HCT123-Q100 is a dual retriggerable monostable multivibrator with reset. The basic output pulse width is programmed by selection of external components ( $R_{EXT}$  and  $C_{EXT}$ ). Once triggered this basic pulse width may be extended by retriggering either of the edge triggered inputs ( $n\overline{A}$  or nB). By repeating this process, the output pulse period ( $nQ = HIGH, n\overline{Q} = LOW$ ) can be made as long as desired. Alternatively, an output delay can be terminated at any time by a LOW-going edge on input  $n\overline{RD}$ . Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

Schmitt-trigger action in the  $n\overline{A}$  and nB inputs, makes the circuit highly tolerant to slower input rise and fall times.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC123-Q100: CMOS level
  - For 74HCT123-Q100: TTL level
- · DC triggered from active HIGH or active LOW inputs
- Retriggerable for very long pulses up to 100 % duty factor
- · Direct reset terminates output pulse
- Schmitt-trigger action on all inputs except for the reset input
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0  $\Omega$ )
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

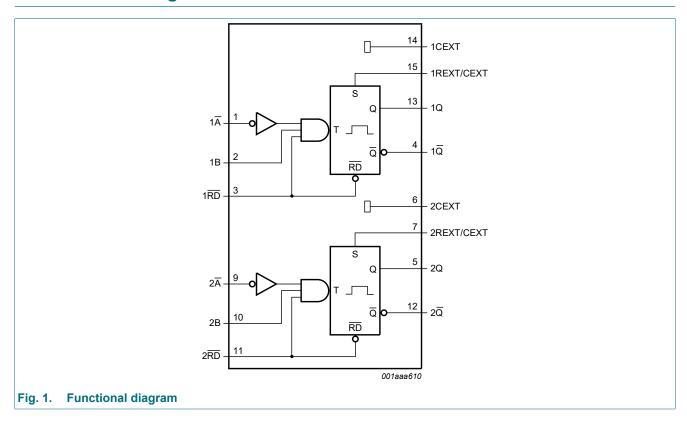


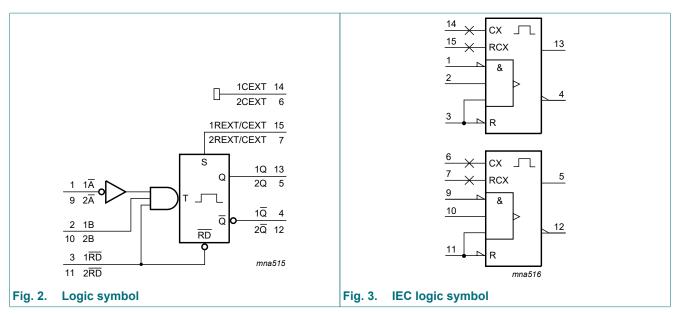
# 3. Ordering information

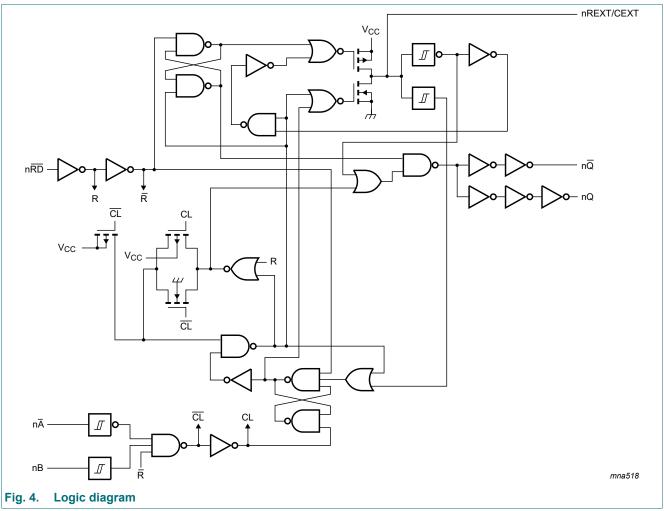
**Table 1. Ordering information** 

Type number	Package	Package											
	Temperature range	Name	Description	Version									
74HC123D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1									
74HCT123D-Q100			body width 3.9 mm										
74HC123PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package;	SOT403-1									
74HCT123PW-Q100			16 leads; body width 4.4 mm										
74HC123BQ-Q100			plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm	SOT763-1									

# 4. Functional diagram

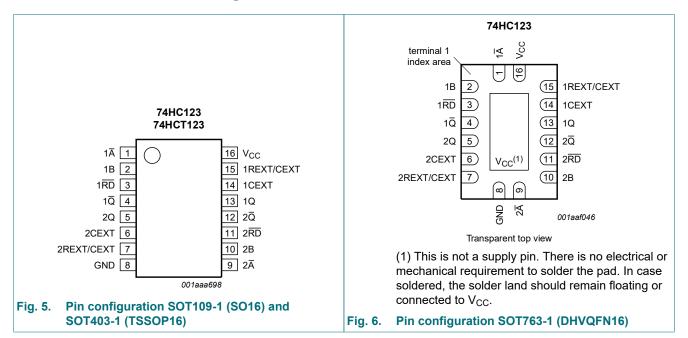






# 5. Pinning information

# 5.1. Pinning



## 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1 <del>A</del>	1	negative-edge triggered input 1
1B	2	positive-edge triggered input 1
1RD	3	direct reset LOW and positive-edge triggered input 1
1Q	4	active LOW output 1
2Q	5	active HIGH output 2
2CEXT	6	external capacitor connection 2
2REXT/CEXT	7	external resistor and capacitor connection 2
GND	8	ground (0 V)
2Ā	9	negative-edge triggered input 2
2B	10	positive-edge triggered input 2
2RD	11	direct reset LOW and positive-edge triggered input 2
2Q	12	active LOW output 2
1Q	13	active HIGH output 1
1CEXT	14	external capacitor connection 1
1REXT/CEXT	15	external resistor and capacitor connection 1
V <sub>CC</sub>	16	supply voltage

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# 6. Functional description

#### Table 3. Function table

 $H = HIGH \text{ voltage level}; L = LOW \text{ voltage level}; X = don't \text{ care}; \uparrow = LOW-to-HIGH \text{ transition}; \downarrow = HIGH-to-LOW \text{ transition};$ 

 $\Pi$  = one HIGH level output pulse;  $\Pi$  = one LOW level output pulse.

	Input		Output					
nRD	nĀ	nB	nQ	nQ				
L	X	Х	L	Н				
X	Н	Х	L [1]	H [1]				
X	X	L	L [1]	H [1]				
Н	L	1	Л	Ц				
Н	<b>↓</b>	Н	Л	П				
1	L	Н	Л	П				

<sup>[1]</sup> If the monostable was triggered before this condition was established, the pulse will continue as programmed.

# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>O</sub>	output current	except for pins nREXT/CEXT; $V_O = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-	-50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	[1]	-	500	mW

<sup>[1]</sup> For SOT109-1 (SO16) package: P<sub>tot</sub> derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P<sub>tot</sub> derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P<sub>tot</sub> derates linearly with 11.2 mW/K above 106 °C.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	74H	IC123-Q	100	74H	Unit		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Δt/ΔV	input transition rise and	nRD input							
	fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C

# 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
74HC123	3-Q100						1		-	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
C <sub>I</sub>	input capacitance		-	3.5	-	-	-	-	-	pF

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	1
74HCT12	23-Q100								-	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	8.0	V
V <sub>OH</sub> HIGH-level		$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 V$								
output voltage		I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
OL	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
		I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	μΑ
ΔI <sub>CC</sub>	additional supply current	per input pin; $I_O = 0$ A; $V_I = V_{CC} - 2.1$ V; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5$ V to $5.5$ V								
		pins nĀ, nB	-	35	125	-	160	-	170	μΑ
		pin nRD	-	50	180	-	225	-	245	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

# 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit see Fig. 12.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC12	3-Q100					1	1		'	
t <sub>pd</sub>	propagation delay	nRD, nA, nB to nQ or nQ; [1] $C_{EXT} = 0$ pF; $R_{EXT} = 5$ k $\Omega$ ; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	-	83	255	-	320	-	385	ns
		V <sub>CC</sub> = 4.5 V	-	30	51	-	64	-	77	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	26	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	24	43	-	54	-	65	ns
		$\overline{\text{NRD}}$ (reset) to $\overline{\text{NQ}}$ or $\overline{\text{NQ}}$ ; $C_{\text{EXT}} = 0$ pF; $R_{\text{EXT}} = 5$ k $\Omega$ ; see Fig. 9								
		V <sub>CC</sub> = 2.0 V	-	66	215	-	270	-	325	ns
		V <sub>CC</sub> = 4.5 V	-	24	43	-	54	-	65	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	19	37	-	46	-	55	ns
t <sub>t</sub>	transition time	see <u>Fig. 9</u> [1]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	nA LOW; see Fig. 10								
		V <sub>CC</sub> = 2.0 V	100	8	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	3	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	2	-	21	-	26	-	ns
		nB HIGH; see Fig. 10								
		V <sub>CC</sub> = 2.0 V	100	17	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	6	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	5	-	21	-	26	-	ns
		nRD LOW; see Fig. 11								
		V <sub>CC</sub> = 2.0 V	100	14	-	125	-	150	-	ns
		V <sub>CC</sub> = 4.5 V	20	5	-	25	-	30	-	ns
		V <sub>CC</sub> = 6.0 V	17	4	-	21	-	26	-	ns
		nQ HIGH and n $\overline{Q}$ LOW; [2] $V_{CC}$ = 5.0 V; see Fig. 10 and Fig. 11								
		$C_{EXT}$ = 100 nF; $R_{EXT}$ = 10 k $\Omega$	-	450	-	-	-	-	-	μs
		$C_{EXT} = 0 \text{ pF};$ $R_{EXT} = 5 \text{ k}\Omega$	-	75	-	-	-	-	-	ns
t <sub>rtrig</sub>	retrigger time	$n\overline{A}$ , nB; $C_{EXT}$ = 0 pF; [3] [4] $R_{EXT}$ = 5 k $\Omega$ ; $V_{CC}$ = 5.0 V; see Fig. 10	-	110	-	-	-	-	-	ns

Symbol	Parameter	Conditions			25 °C		-40 °C t	o +85 °C	-40 °C to +125 °C		Unit
				Min	Тур	Max	Min	Max	Min	Max	
R <sub>EXT</sub>	external timing	see Fig. 7									
	resistor	V <sub>CC</sub> = 2.0 V		10	-	1000	-	-	-	-	kΩ
		V <sub>CC</sub> = 5.0 V		2	-	1000	-	-	-	-	kΩ
C <sub>EXT</sub>	external timing capacitor	V <sub>CC</sub> = 5.0 V; see <u>Fig. 7</u>	[4]	-	-	-	-	-	-	-	pF
C <sub>PD</sub>	power dissipation capacitance	per monostable; $V_I = GND$ to $V_{CC}$	[5]	-	54	-	-	-	-	-	pF
74HCT1	23-Q100										
t <sub>PHL</sub>	HIGH to LOW propagation delay	$nRD$ , $n\overline{A}$ , $nB$ to $nQ$ or $n\overline{Q}$ ; $C_{EXT} = 0$ pF; $R_{EXT} = 5$ kΩ; see Fig. 9									
		V <sub>CC</sub> = 4.5 V		-	30	51	-	64	-	77	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	26	-	-	-	-	-	ns
		$\overline{\text{NRD}}$ (reset) to nQ or n $\overline{\text{Q}}$ ; $C_{\text{EXT}}$ = 0 pF; $R_{\text{EXT}}$ = 5 k $\Omega$ ; see Fig. 9									
		V <sub>CC</sub> = 4.5 V		-	27	46	-	58	-	69	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	23	-	-	-	-	-	ns
	LOW to HIGH propagation delay	n $\overline{RD}$ , n $\overline{A}$ , nB to nQ or n $\overline{Q}$ ; $C_{EXT}$ = 0 pF; $R_{EXT}$ = 5 k $\Omega$ ; see Fig. 9									
		V <sub>CC</sub> = 4.5 V		-	28	51	-	64	-	77	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	26	-	-	-	-	-	ns
		nRD (reset) to nQ or nQ; $C_{EXT} = 0$ pF; $R_{EXT} = 5$ k $\Omega$ ; see Fig. 9									
		V <sub>CC</sub> = 4.5 V		-	23	46	-	58	-	69	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	23	-	-	-	-	-	ns
t <sub>t</sub>	transition time	V <sub>CC</sub> = 4.5 V; see <u>Fig. 9</u>	[1]	-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	V <sub>CC</sub> = 4.5 V									
		nĀ LOW; see Fig. 10		20	3	-	25	-	30	-	ns
		nB HIGH; see Fig. 10		20	5	-	25	-	30	-	ns
		nRD LOW; see Fig. 11		20	7	-	25	-	30	-	ns
		nQ HIGH and n $\overline{Q}$ LOW; V <sub>CC</sub> = 5.0 V; see Fig. 10 and Fig. 11	[2]								
		$C_{EXT}$ = 100 nF; $R_{EXT}$ = 10 k $\Omega$		-	450	-	-	-	-	-	μs
		$C_{EXT} = 0 \text{ pF};$ $R_{EXT} = 5 \text{ k}\Omega$		-	75	-	-	-	-	-	ns
t <sub>rtrig</sub>	retrigger time	n $\overline{A}$ , nB; C <sub>EXT</sub> = 0 pF; [3 R <sub>EXT</sub> = 5 k $\Omega$ ; V <sub>CC</sub> = 5.0 V; see Fig. 10	3] [4]	-	110	-	-	-	-	-	ns
R <sub>EXT</sub>	external timing resistor	V <sub>CC</sub> = 5.0 V; see <u>Fig. 7</u>		2	-	1000	-	-	-	-	kΩ
C <sub>EXT</sub>	external timing capacitor	V <sub>CC</sub> = 5.0 V; see <u>Fig. 7</u>	[4]	-	-	-	-	-	-	-	pF

Symbol	Parameter	Conditions	25 °C			-40 °C to	+85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
C <sub>PD</sub>	power dissipation capacitance	per monostable; [5] $V_I = GND$ to $V_{CC}$ - 1.5 V	-	56	-	-	-	-	-	pF

- $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ ;  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$  For other  $R_{EXT}$  and  $C_{EXT}$  combinations see <u>Fig. 7</u>. If  $C_{EXT} > 10$  nF, the next formula is valid.

 $t_W = K \times R_{EXT} \times C_{EXT}$ , where:

t<sub>W</sub> = typical output pulse width in ns;

 $R_{EXT}$  = external resistor in k $\Omega$ ;

C<sub>EXT</sub> = external capacitor in pF;

K = constant = 0.45 for  $V_{CC}$  = 5.0 V and 0.55 for  $V_{CC}$  = 2.0 V.

The inherent test jig and pin capacitance at pins 15 and 7 (nREXT/CEXT) is approximately 7 pF.

The time to retrigger the monostable multivibrator depends on the values of R<sub>EXT</sub> and C<sub>EXT</sub>. The output pulse width will only be extended when the time between the active-going edges of the trigger input pulses meets the minimum retrigger time. If C<sub>EXT</sub> >10 pF, the next formula (at V<sub>CC</sub> = 5.0 V) for the setup time of a retrigger pulse is valid:  $t_{rtrig} = 30 + 0.19 \times R_{EXT} \times C_{EXT}^{0.9} + 13 \times R_{EXT}^{1.05}$ , where:

 $t_{rtrig}$  = retrigger time in ns;

 $C_{EXT}$  = external capacitor in pF;  $R_{EXT}$  = external resistor in k $\Omega$ .

The inherent test jig and pin capacitance at pins 15 and 7 (nREXT/CEXT) is 7 pF.

- When the device is powered-up, initiate the device via a reset pulse, when  $C_{EXT} < 50 \text{ pF}$ .
- $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o) + 0.75 \times C_{EXT} \times V_{CC}^2 \times f_o + D \times 16 \times V_{CC}$  where:

f<sub>i</sub> = input frequency in MHz;

fo = output frequency in MHz;

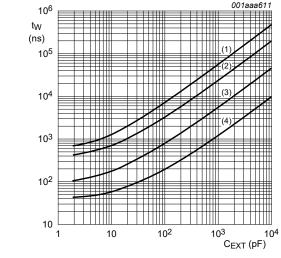
D = duty factor in %;

C<sub>I</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

C<sub>EXT</sub> = timing capacitance in pF;

 $\Sigma(C_L \times V_{CC})^2 \times f_0$ ) sum of outputs.



 $V_{CC} = 5.0 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

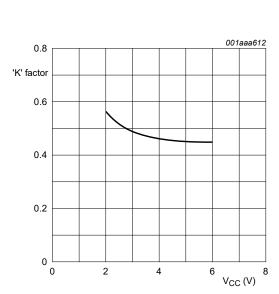
(1)  $R_{EXT} = 100 \text{ k}\Omega$ 

(2)  $R_{EXT} = 50 \text{ k}\Omega$ 

(3)  $R_{EXT} = 10 k\Omega$ 

(4)  $R_{FXT} = 2 k\Omega$ 

Fig. 7. Typical output pulse width as a function of the external capacitor value

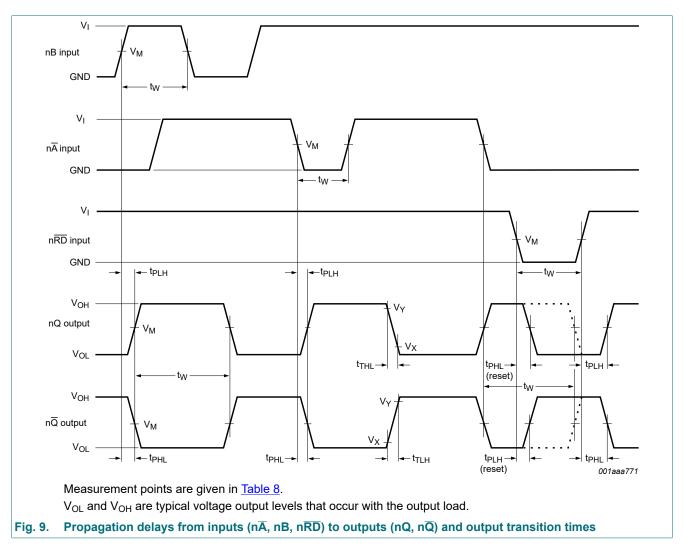


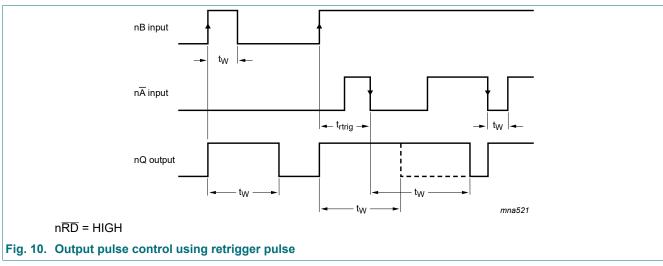
 $C_{EXT}$  = 10 nF;  $R_{EXT}$  = 10 k $\Omega$  to 100 k $\Omega$ .

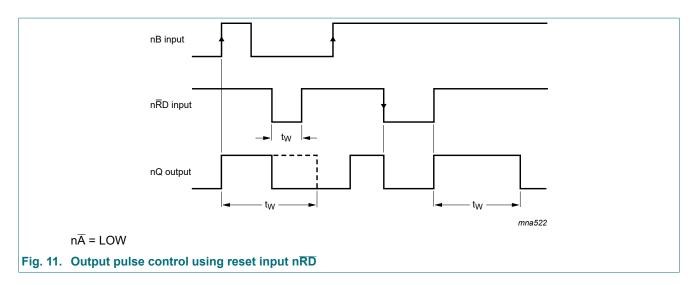
 $T_{amb} = 25 \, ^{\circ}C.$ 

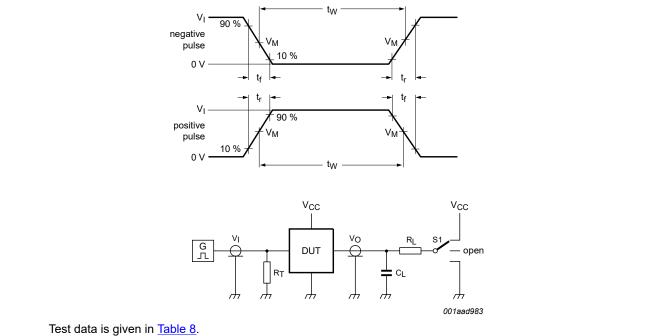
Fig. 8. 74HC123-Q100 typical 'K' factor as function of  $V_{CC}$ 

### 10.1. Waveforms and test circuit









Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $C_L$  = Load capacitance including jig and probe capacitance.

R<sub>L</sub> = Load resistance.

S1 = Test selection switch.

Fig. 12. Test circuit for measuring switching times

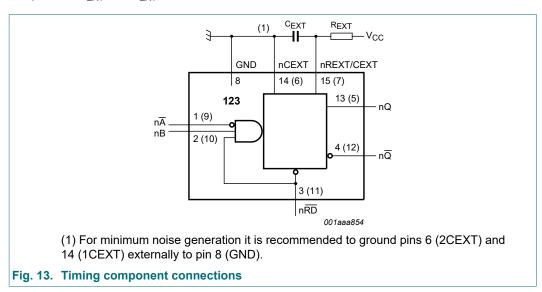
Table 8. Test data

Туре	Input		Load	Load				
	$V_{l}$ $t_{r}, t_{f}$		CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>			
74HC123-Q100	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open			
74HCT123-Q100	3 V	6 ns	15 pF, 50 pF	1 kΩ	open			

# 11. Application information

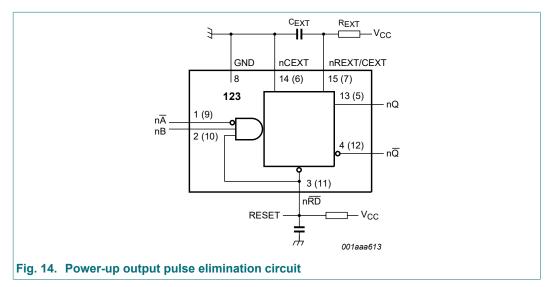
# 11.1. Timing component connections

The basic output pulse width is essentially determined by the values of the external timing components  $R_{\text{EXT}}$  and  $C_{\text{EXT}}$ .



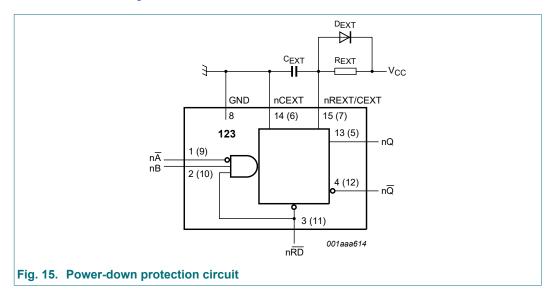
## 11.2. Power-up considerations

When the monostable is powered-up it may produce an output pulse, with a pulse width defined by the values of  $R_{\text{EXT}}$  and  $C_{\text{EXT}}$ . This output pulse can be eliminated using the circuit shown in Fig. 14.



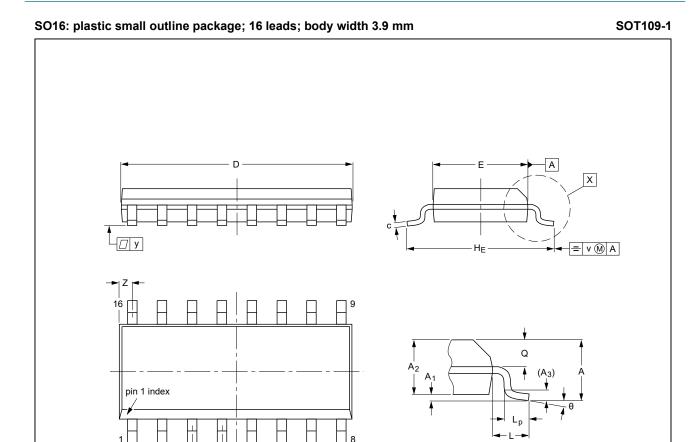
### 11.3. Power-down considerations

A large capacitor  $C_{\text{EXT}}$  may cause problems when powering-down the monostable due to the energy stored in this capacitor. When a system containing this device is powered-down or a rapid decrease of  $V_{\text{CC}}$  to zero occurs, the monostable may sustain damage, due to the capacitor discharging through the input protection diodes. To avoid this possibility, use a damping diode  $(D_{\text{EXT}})$  preferably a germanium or Schottky type diode able to withstand large current surges and connect as shown in Fig. 15.



detail X

# 12. Package outline



0 2.5 5 mm scale

 $b_p \longrightarrow w M$ 

#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 16. Package outline SOT109-1 (SO16)

**Product data sheet** 

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

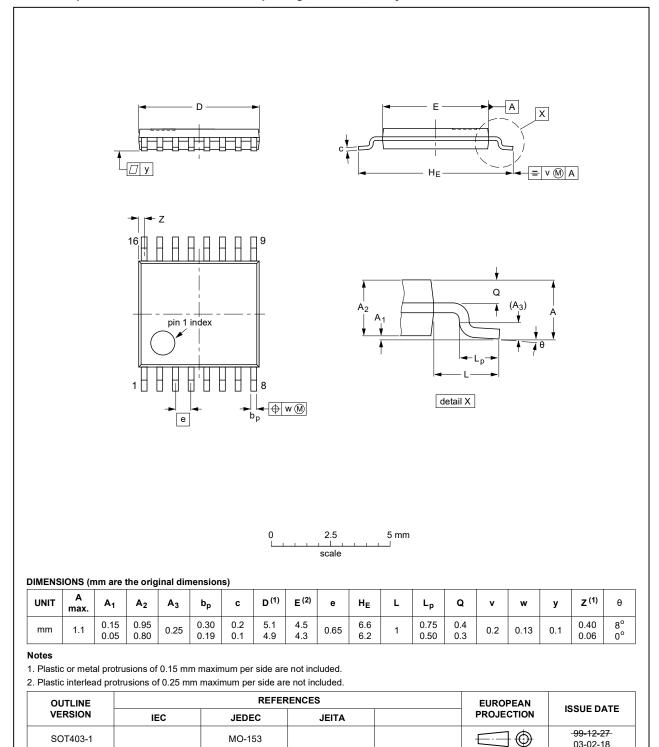


Fig. 17. Package outline SOT403-1 (TSSOP16)

MO-153

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03-02-18

**Product data sheet** 

SOT403-1

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

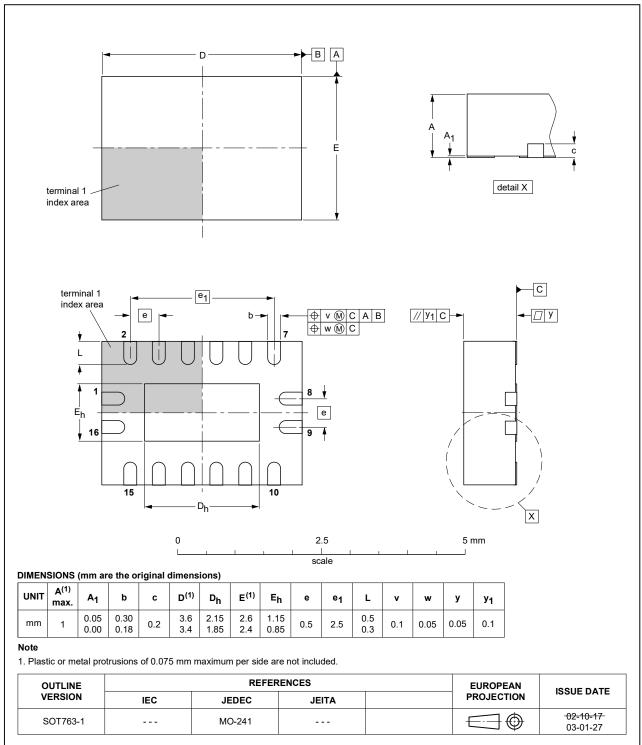


Fig. 18. Package outline SOT763-1 (DHVQFN16)

# 13. Abbreviations

#### **Table 9. Abbreviations**

Acronym	Abbreviation
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT123_Q100 v.3	20200903	Product data sheet	-	74HC_HCT123_Q100 v.2
Modifications:	Nexperia. Legal texts have Section 1 and	this data sheet has been redes we been adapted to the new co Section 2 updated. ng values for P <sub>tot</sub> total power o	ompany name where	appropriate.
74HC_HCT123_Q100 v.2	20150119	Product data sheet	-	74HC_HCT123_Q100 v.1
Modifications:	• <u>Table 7</u> : Power	r dissipation capacitance cond	ition for 74HCT123-0	Q100 is corrected.
74HC_HCT123_Q100 v.1	20120801	Product data sheet	-	-

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# 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

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74HC\_HCT123\_Q100

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